

## 1. Global joint venture starts operations as WeEn Semiconductors

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WeEn Semiconductors



# BT151-800R

SCR, 12 A, 15mA, 800 V, SOT78

Rev. 05 — 2 March 2009

**Product data sheet** 

## **Product profile**

## 1.1 General description

Planar passivated SCR (Silicon Controlled Rectifier) in a SOT78 plastic package.

### 1.2 Features and benefits

High reliability

■ High thermal cycling performance

■ High surge current capability

## 1.3 Applications

Ignition circuits

■ Protection Circuits

Motor control

Static switching

#### 1.4 Quick reference data

#### Table 1. **Quick reference**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage		-	-	800	V
$I_{T(AV)}$	average on-state current	half sine wave; T <sub>mb</sub> ≤ 109 °C; see <u>Figure 3</u>	-	-	7.5	Α
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; $T_{mb} \le 109 ^{\circ}\text{C}$ ; see Figure 1; see Figure 2	-	-	12	Α
Static ch	aracteristics					
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V; } T_j = 25 \text{ °C;}$ $I_T = 100 \text{ mA; see } \frac{\text{Figure 8}}{\text{Figure 8}}$	-	2	15	mA



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## 2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	Α	anode	mb	A - K
3	G	gate	205	G sym037
mb	mb	anode		
			SOT78 (TO-220AB;SC-46	6)

## 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BT151-800R	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage		-	800	V
$V_{RRM}$	repetitive peak reverse voltage		-	800	V
$I_{T(AV)}$	average on-state current	half sine wave; T <sub>mb</sub> ≤ 109 °C; see <u>Figure 3</u>	-	7.5	Α
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; $T_{mb} \le 109$ °C; see <u>Figure 1</u> ; see <u>Figure 2</u>	-	12	Α
dl <sub>T</sub> /dt	rate of rise of on-state current	$I_T = 20 \text{ A}$ ; $I_G = 50 \text{ mA}$ ; $dI_G/dt = 50 \text{ mA/}\mu\text{s}$	-	50	A/µs
I <sub>GM</sub>	peak gate current		-	2	А
$P_{GM}$	peak gate power		-	5	W
T <sub>stg</sub>	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C
I <sub>TSM</sub>	non-repetitive peak	half sine wave; $t_p = 8.3 \text{ ms}$ ; $T_{j(init)} = 25 ^{\circ}\text{C}$	-	132	Α
	on-state current	half sine wave; $t_p = 10$ ms; $T_{j(init)} = 25$ °C; see Figure 4; see Figure 5	-	120	Α
l <sup>2</sup> t	I2t for fusing	t <sub>p</sub> = 10 ms; sine-wave pulse	-	72	A <sup>2</sup> s
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.5	W
$V_{RGM}$	peak reverse gate voltage		-	5	V

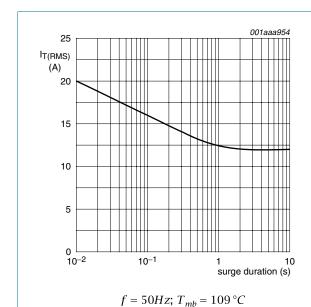


Fig 1. RMS on-state current as a function of surge duration; maximum values

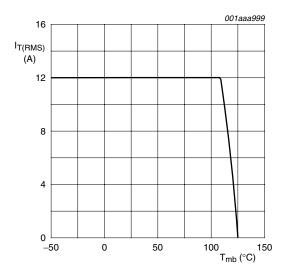
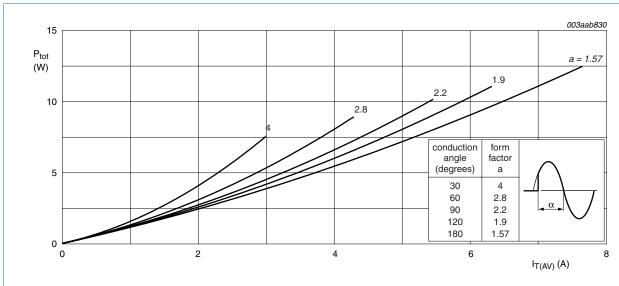


Fig 2. RMS on-state current as a function of mounting base temperature; maximum values

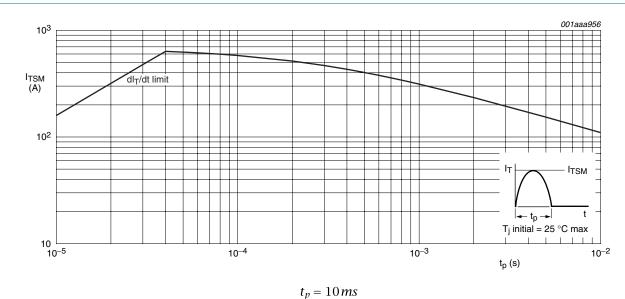
BT151-800R

SCR, 12 A, 15mA, 800 V, SOT78



a =form factor  $= I_{T(RMS)} / I_{T(AV)}$ 

Fig 3. Total power dissipation as a function of average on-state current; maximum values



Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values Fig 4.

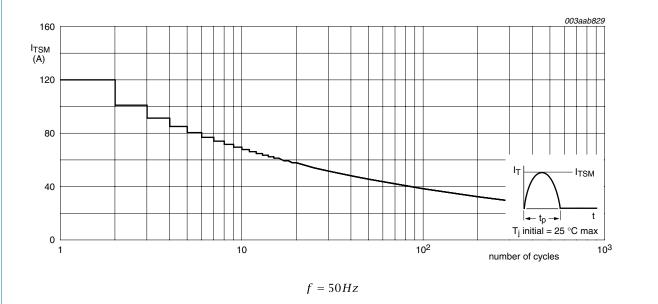
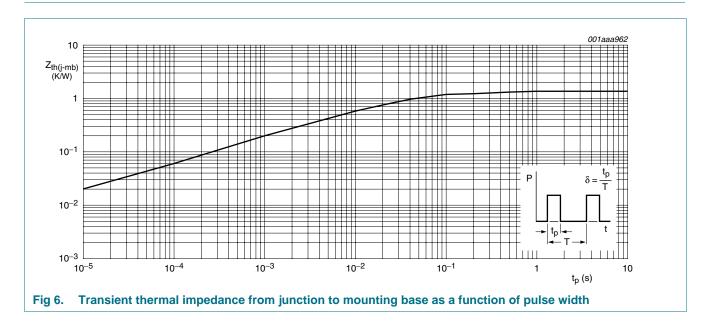


Fig 5. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

### 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 6	-	-	1.3	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air		-	60	-	K/W



## 6. Characteristics

Table 6. Characteristics

Table 0.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V; } T_j = 25 \text{ °C; } I_T = 100 \text{ mA; see}$ Figure 8	-	2	15	mA
IL	latching current	$V_D = 12 \text{ V}; T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure 9}}{Minimum of the properties of the properti$	-	10	40	mA
I <sub>H</sub>	holding current	$V_D = 12 \text{ V; } T_j = 25 \text{ °C; see } \frac{\text{Figure 10}}{\text{ occ}}$	-	7	20	mA
$V_{T}$	on-state voltage	I <sub>T</sub> = 23 A; T <sub>j</sub> = 25 °C; see <u>Figure 11</u>	-	1.4	1.75	V
$V_{GT}$	gate trigger voltage	$I_T$ = 100 mA; $V_D$ = 12 V; $T_j$ = 25 °C; see Figure 12	-	0.6	1.5	V
		$I_T = 100 \text{ mA}; V_D = 800 \text{ V}; T_j = 125 \text{ °C}$	0.25	0.4	-	V
$I_D$	off-state current	V <sub>D</sub> = 800 V; T <sub>j</sub> = 125 °C	-	0.1	0.5	mA
I <sub>R</sub>	reverse current	V <sub>R</sub> = 800 V; T <sub>j</sub> = 125 °C	-	0.1	0.5	mA
Dynamic	characteristics					
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 536 V; $T_j$ = 125 °C; exponential waveform; gate open circuit	50	130	-	V/µs
		$V_{DM}$ = 536 V; $T_j$ = 125 °C; $R_{GK}$ = 100 Ω; exponential waveform; see Figure 7	200	1000	-	V/µs
t <sub>gt</sub>	gate-controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = 800 \text{ V}; I_G = 100 \text{ mA};$ $dI_G/dt = 5 \text{ A}/\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	2	-	μs
t <sub>q</sub>	commutated turn-off time	$V_{DM} = 536 \text{ V; } T_j = 125 \text{ °C; } I_{TM} = 20 \text{ A;}$ $V_R = 25 \text{ V; } (dI_T/dt)_M = 30 \text{ A/µs;}$ $dV_D/dt = 50 \text{ V/µs; } R_{GK} = 100 \Omega$	-	70	-	μs

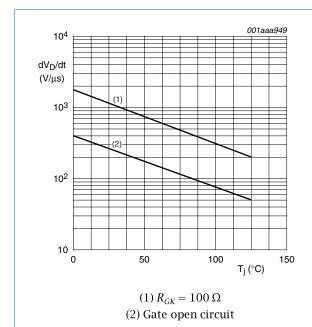


Fig 7. Critical rate of rise of off-state voltage as a function of junction temperature; minimum values

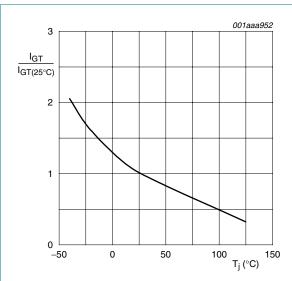


Fig 8. Normalized gate trigger current as a function of junction temperature

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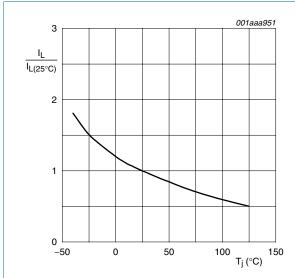


Fig 9. Normalized latching current as a function of junction temperature

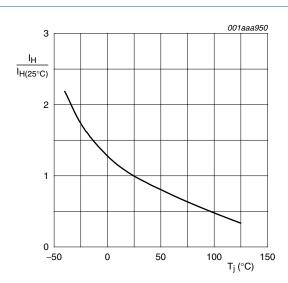
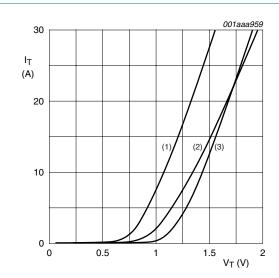


Fig 10. Normalized holding current as a function of junction temperature



 $V_0 = 1.06 \ V; R_s = 0.0304 \ \Omega$ (1)  $T_j = 150$  °C; typical values (2)  $T_j = 150$  °C; maximum values (3)  $T_j = 25$  °C; maximum values

Fig 11. On-state current as a function of on-state voltage

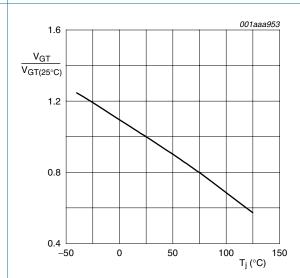
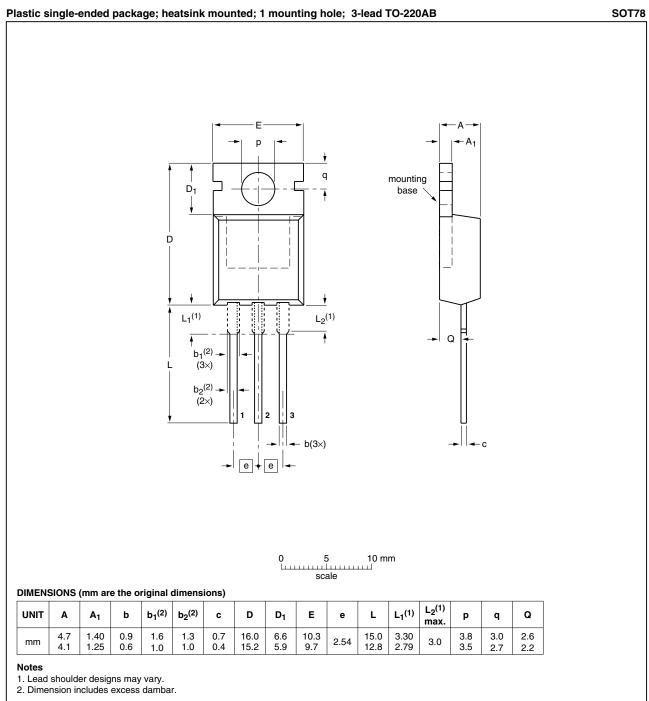


Fig 12. Normalized gate trigger voltage as a function of junction temperature

## 7. Package outline



OUTLINE VERSION		REFER	ENCES	EUROPEAN	ISSUE DATE
	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT78		3-lead TO-220AB	SC-46		<del>08-04-23</del> 08-06-13

Fig 13. Package outline SOT78 (TO-220AB)

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## 8. Revision history

### Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BT151-800R_5	20090302	Product data sheet	-	BT151_SER_L_R_4
Modifications:	Package ou	utline updated.		
	<ul> <li>Type numb</li> </ul>	er BT151-800R separated	from data sheet BT151	_SER_L_R_4.
BT151_SER_L_R_4	20061023	Product data sheet	-	BT151_SERIES_3
BT151_SERIES_3 (9397 750 13159)	20040607	Product specification	-	BT151_SERIES_2
BT151_SERIES_2	19990601	Product specification	-	BT151_SERIES_1
BT151_SERIES_1	19970901	Product specification	-	-

NXP Semiconductors BT151-800R
SCR, 12 A, 15mA, 800 V, SOT78

## 9. Legal information

#### 9.1 Data sheet status

Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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BT151-800R

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